



Part Number : 787873054

Series Number : 78787

Product Category : PCB Headers and Receptacles

Product Description : 2.00mm Pitch Milli-Grid Receptacle, Vertical, Through Hole, Dual Row, 1.91mm Tail Length, Tin Plating, 30 Circuits, Lead-Free

Status : Active

Documents & Resources

Drawings

Drawing 787873054_sd.pdf

Packaging Design Drawing PK-78787-001-001.pdf

3D Models and Design Files

3D Model 787873054_stp.zip


Specifications

Application Specification 503940001-AS-000.pdf

Product Specification PS-78787-001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2023)8585-DC (23 Jan 2024)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D

- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	78787
Description	2.00mm Pitch Milli-Grid Receptacle, Vertical, Through Hole, Dual Row, 1.91mm Tail Length, Tin Plating, 30 Circuits, Lead-Free
Application	Board-to-Board, Signal
Component Type	PCB Receptacle
Product Family	Milli-Grid Connector System
Product Name	Milli-Grid
UPC	889056230636

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	125V AC (RMS)/DC

Physical

Circuits (Loaded)	30
Circuits (maximum)	30
Color - Resin	Black
Durability (mating cycles max)	30
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No

Keying to Mating Part	None
Lock to Mating Part	None
Material - Metal	Copper Alloy
Material - Plating Mating	Tin
Material - Plating Termination	Tin
Material - Resin	Liquid Crystal Polymer
Net Weight	0.870/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tube
PC Tail Length	1.91mm
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	0.80mm
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	2.500µm
Plating min - Termination	2.500µm
Polarized to Mating Part	No
Polarized to PCB	No
Stackable	No
Temperature Range - Operating	0° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	10
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
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Milli-Grid Vertical Through Hole Headers	<u>87758</u>
Milli-Grid Vertical Surface Mount Headers	<u>87759</u>
Milli-Grid Right-Angle Through Hole Headers	<u>87760</u>
Milli-Grid Vertical, Dual Row, Through Hole Headers	<u>87831</u>
Milli-Grid Vertical, Dual Row, Surface Mount Headers	<u>87832</u>
Milli-Grid Right-Angle Dual Row Through Hole Headers	<u>87833</u>
Milli-Grid Vertical, Dual Row, Through Hole Headers	<u>151117</u>
Milli-Grid Vertical, Dual Row, Surface Mount Headers	<u>151118</u>
Milli-Grid Right-Angle, Dual Row, Through Hole Headers	<u>151119</u>
Milli-Grid Right-Angle, Dual Row, Surface Mount Headers	<u>151120</u>